Rectifier diodes ultrafast, rugged

Product specification

BYW29E series

FEATURES

- · Low forward volt drop
- Fast switching

power supplies.

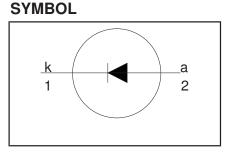
- Soft recovery characteristic
- Reverse surge capability
 High thermal cycling performance
 Low thermal resistance

GENERAL DESCRIPTION

Ultra-fast, epitaxial rectifier diodes intended for use as output rectifiers

in high frequency switched mode

The BYW29E series is supplied in the conventional leaded SOD59



PINNING

PIN DESCRIPTION 1 cathode 2 anode tab cathode

$t_{rr} \le 25 \text{ ns}$

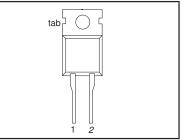
QUICK REFERENCE DATA

 $V_{\rm R} = 100 \text{V} / 150 \text{ V} / 200 \text{ V}$

 $V_F \le 0.895 V$

 $I_{F(AV)} = 8 A$ $I_{\text{RRM}} \leq 0.2 \text{ A}$

SOD59 (TO220AC)



LIMITING VALUES

(TO220AC) package.

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	N. MAX.		UNIT	
		BYW29E		-100	-150	-200	
V _{RRM}	Peak repetitive reverse voltage		-	100	150	200	V
V _{RWM}	Working peak reverse voltage		-	100	150	200	V
V _R	Continuous reverse voltage		-	100	150	200	V
I _{F(AV)}	Average rectified forward current	square wave; $\delta = 0.5$; $T_{mb} \le 128$ °C	-		8		A
I _{FRM}	Repetitive peak forward current	square wave; $\delta = 0.5$; $T_{mb} \le 128$ °C	-		16		A
I _{FSM}	Non-repetitive peak forward current	t = 10 ms t = 8.3 ms sinusoidal; with reapplied V _{RRM(max)}	-		80 88		A A
I _{RRM}	Peak repetitive reverse surge current	$t_p = 2 \ \mu s; \ \delta = 0.001$	-		0.2		A
I _{RSM}	Peak non-repetitive reverse surge current	t _p = 100 μs	-		0.2		А
T _j	Operating junction		-		150		°C
T _{stg}	temperature Storage temperature		- 40		150		°C

ESD LIMITING VALUE

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _c	Electrostatic discharge capacitor voltage	Human body model; C = 250 pF; R = 1.5 k Ω	-	8	kV

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THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-mb}	Thermal resistance junction		-	-	2.7	K/W
R _{th j-a}	to mounting base Thermal resistance junction to ambient	in free air	-	60	-	K/W

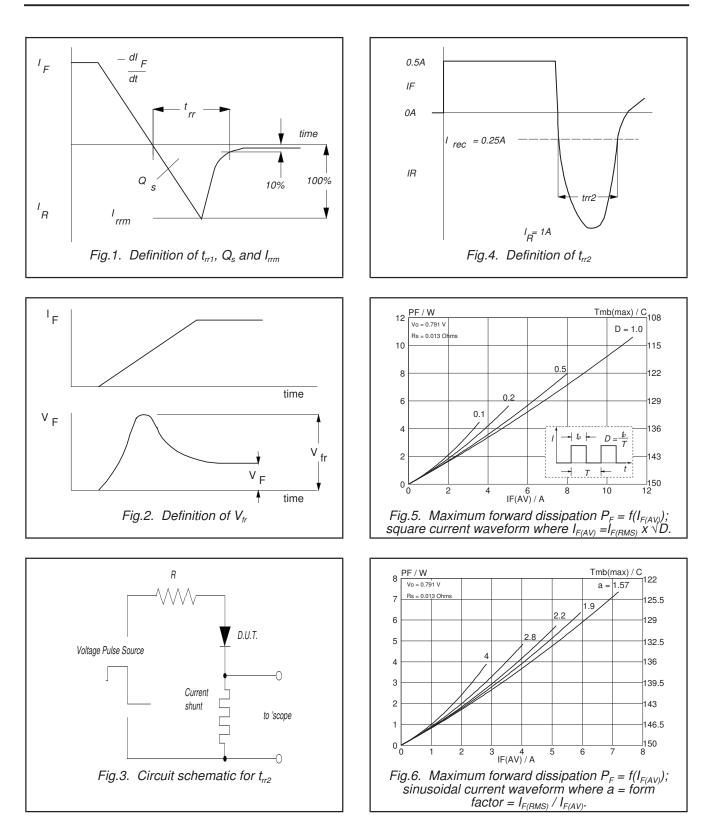
ELECTRICAL CHARACTERISTICS

 $T_i = 25$ °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage	I _F = 8 A; T _i = 150°C	-	0.8	0.895	V
		$ I_F = 8 \text{ A}$	-	0.92	1.05	V
		$I_{\rm F} = 20 {\rm A}$	-	1.1	1.3	V
I _B	Reverse current	$\dot{V}_{R} = V_{RWM}$	-	2	10	μA
		$V_{\rm B} = V_{\rm BWM}; T_{\rm i} = 100^{\circ}{\rm C}$	-	0.2	0.6	ΜḿΑ
Q _{rr}	Reverse recovered charge	$I_{\rm F} = 2 \text{ A}; V_{\rm B} \ge 30 \text{ V}; -dI_{\rm F}/dt = 20 \text{ A}/\mu\text{s}$	-	4	11	nC
t _{rr1}	Reverse recovery time	$I_{\rm F} = 1 \text{ A}; V_{\rm B} \ge 30 \text{ V}; -dI_{\rm F}/dt = 100 \text{ A}/\mu \text{s}$		20	25	ns
+	Reverse recovery time	$I_{\rm F} = 0.5$ Å to $I_{\rm B} = 1$ Å; $I_{\rm rec} = 0.25$ Å	-	15	20	ns
ι _{rr2} V _{fr}	Forward recovery voltage	$I_{F} = 0.5$ Å to $I_{R} = 1$ Å; $I_{rec} = 0.25$ Å $I_{F} = 1$ Å; $dI_{F}/dt = 10$ Å/µs	-	1	-	V

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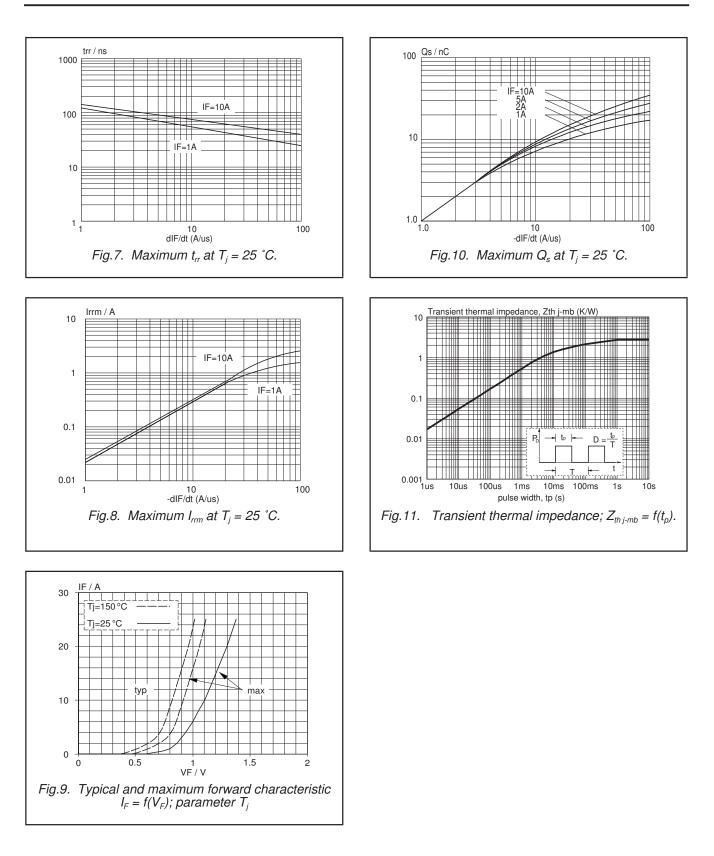


August 2001

Product specification

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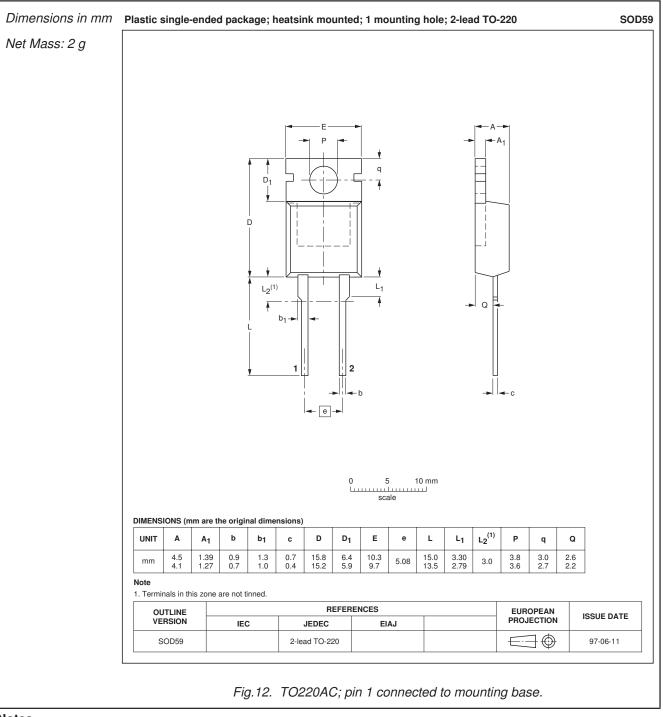
BYW29E series



BYW29E series

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MECHANICAL DATA



Notes

Refer to mounting instructions for TO220 envelopes.
 Epoxy meets UL94 V0 at 1/8".

Legal information

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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Customer notification

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Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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